

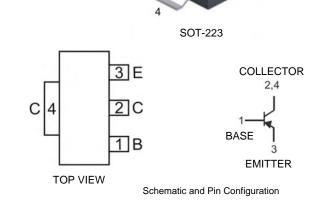


PNP SURFACE MOUNT TRANSISTOR

3

Features

- Epitaxial Planar Die Construction
- Complementary NPN Type Available (DZT853)
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- **Mechanical Data**
- Case: SOT-223
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin annealed over Copper Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Marking & Type Code Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.115 grams (approximate)



Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|---|----------------------|------------------------|------|
| Collector-Base Voltage | V _{CBO} | -140 | V |
| Collector-Emitter Voltage | V _{CEO} | -100 | V |
| Emitter-Base Voltage | V _{EBO} | -6 | V |
| Continuous Collector Current | Ι _C | -5 | A |
| Power Dissipation | P _{tot} | 1(Note 3) 3(Note 4) | W |
| Operating and Storage Temperature Range | Tj, T _{STG} | -55 to +150 | °C |

Notes: 1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

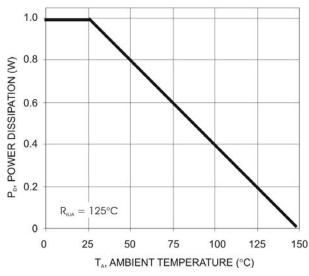
- 3. Device mounted on FR-4 PCB, pad layout as shown on page 4.
- 4. The power which can be dissipated, assuming the device is mounted in a typical manner on a PCB with copper equal to 4 square inch minimum.



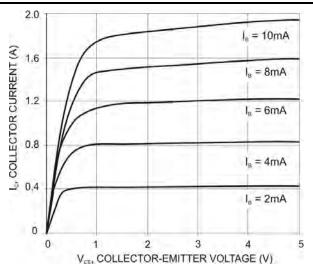
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--------------------------------------|-------------------------------------|------------------------|----------------------------|-----------------------------|----------|---|--|
| OFF CHARACTERISTICS | | | | | | | |
| Collector-Base Breakdown Voltage | V _{(BR)CBO} | -140 | | _ | V | $I_{\rm C} = -100 \mu A, I_{\rm E} = 0$ | |
| Collector-Emitter Breakdown Voltage | V _{(BR)CEO} | -100 | _ | _ | V | $I_{\rm C} = -10 {\rm mA}^*, I_{\rm B} = 0$ | |
| Emitter-Base Breakdown Voltage | V _{(BR)EBO} | -6 | _ | _ | V | $I_{E} = -100 \mu A, I_{C} = 0$ | |
| Collector Cutoff Current | | — — -50 -1 | | | nA μA | $V_{CB} = -100V, I_E = 0$ $V_{CB} = -100V, I_E = 0, T_A = 100^{\circ}C$ | |
| Emitter Cutoff Current | I _{EBO} | _ | _ | -10 | nA | $V_{EB} = -6V, I_{C} = 0$ | |
| ON CHARACTERISTICS | | | | | | | |
| Collector-Emitter Saturation Voltage | V _{CE(SAT)} | | -20 -90 -160 -300 | -50 -115 -220 -420 | mV | $\begin{split} I_{C} &= -100 \text{mA}, \ I_{B} &= -10 \text{mA}^{*} \\ I_{C} &= -1\text{A}, \ I_{B} &= -100 \text{mA}^{*} \\ I_{C} &= -2\text{A}, \ I_{B} &= -200 \text{mA}^{*} \\ I_{C} &= -4\text{A}, \ I_{B} &= -400 \text{mA}^{*} \end{split}$ | |
| Base-Emitter Saturation Voltage | V _{BE(SAT)} | _ | -1010 | -1170 | mV | $I_{\rm C} = -4A, I_{\rm B} = -400 \text{mA}^*$ | |
| Base-Emitter Turn-On Voltage | V _{BE(ON)} | _ | -925 | -1160 | mV | $I_{CE} = -4A, V_{CE} = -1V^*$ | |
| DC Current Gain | h _{FE} | 100 100 50 30 | — — — 15 | 300 | _ | $ \begin{split} & I_C = -10 mA, \ V_{CE} = -1 V^* \\ & I_C = -1A, \ V_{CE} = -1 V^* \\ & I_C = -3A, \ V_{CE} = -1 V^* \\ & I_C = -4A, \ V_{CE} = -1 V^* \\ & I_C = -10A, \ V_{CE} = -1 V^* \end{split} $ | |
| SMALL SIGNAL CHARACTERISTICS | | | | | | | |
| Current Gain-Bandwidth Product | f⊤ | _ | 125 | _ | MHz | $I_{C} = -100 \text{mA}, V_{CE} = -10 \text{V},$ f = 50MHz | |
| Output Capacitance | C _{obo} | | 65 | — | pF | $V_{CB} = -10V$, f = 1MHz | |
| SWITCHING CHARACTERISTICS | | | | | · | | |
| Switching Times | t _{on} t _{off} | _ | 110 460 | _ | ns | $I_{C} = -2A, I_{B1} = -200mA$ $I_{B2} = 200mA, V_{CC} = -10V$ | |

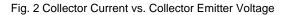
*Measured under pulsed conditions. Pulse width = 300 μs . Duty cycle ${\leq}2\%$

Typical Characteristics $@T_{amb} = 25^{\circ}C$ unless otherwise specified





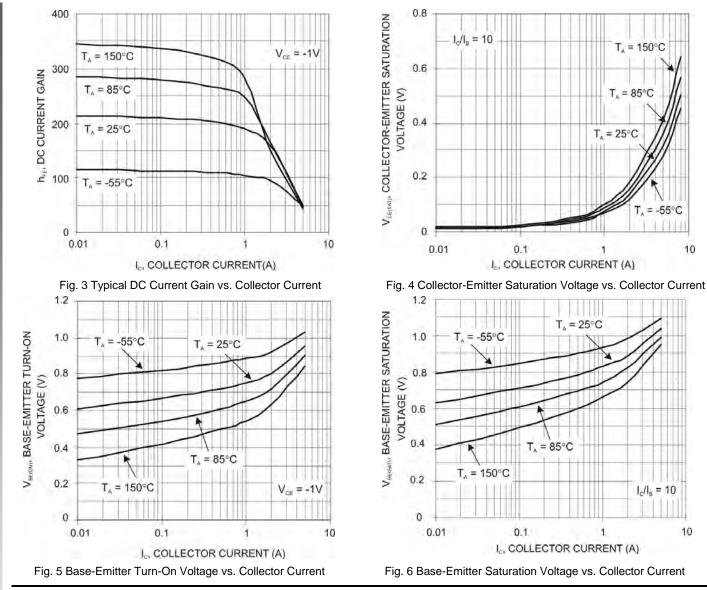




Notes: 3. Device mounted on FR-4 PCB, pad layout as shown on page 4.



NEW PRODUCT

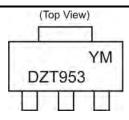


Ordering Information (Note 5)

| Device | Valid Marking Codes | Packaging | Shipping |
|-----------|---------------------|-----------|------------------|
| DZT953-13 | DZT953 | SOT-223 | 2500/Tape & Reel |
| DZT953-13 | PT06 | SOT-223 | 2500/Tape & Reel |

Notes: 5. Packaging Details as shown on page 4, or go to our website at http://www.diodes.com/ap2007.pdf.

Marking Information



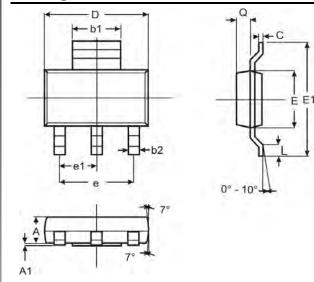
DZT953 or PT06= Product Type Marking Code YM = Date Code Marking Y = Year ex: T = 2006

M = Month ex: 9 = September

| Date Code Key | | | | | | | | | | | | |
|---------------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Year | 200 | 6 | 2007 | | 2008 | 20 | 09 | 2010 | | 2011 | 1 | 2012 |
| Code | Т | | U | | V | V | V | Х | | Y | | Z |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |

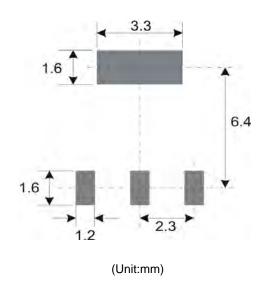


Package Outline Dimensions



| SOT-223 | | | | | | | |
|---------|----------------------|------|------|--|--|--|--|
| Dim | Min | Тур | | | | | |
| Α | 1.55 | 1.65 | 1.60 | | | | |
| A1 | 0.010 | 0.15 | 0.05 | | | | |
| b1 | 2.90 | 3.10 | 3.00 | | | | |
| b2 | 0.60 | 0.80 | 0.70 | | | | |
| С | 0.20 | 0.30 | 0.25 | | | | |
| D | 6.45 | 6.55 | 6.50 | | | | |
| Е | 3.45 | 3.55 | 3.50 | | | | |
| E1 | 6.90 | 7.10 | 7.00 | | | | |
| e | _ | l | 4.60 | | | | |
| e1 | _ | _ | 2.30 | | | | |
| L | 0.85 | 1.05 | 0.95 | | | | |
| q | 0.84 | 0.94 | 0.89 | | | | |
| All C | All Dimensions in mm | | | | | | |

Suggested Pad Layout: (Based on IPC-SM-782)



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